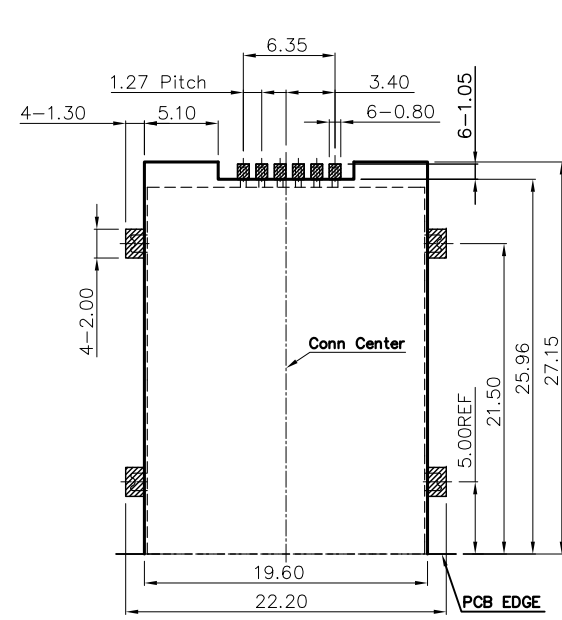
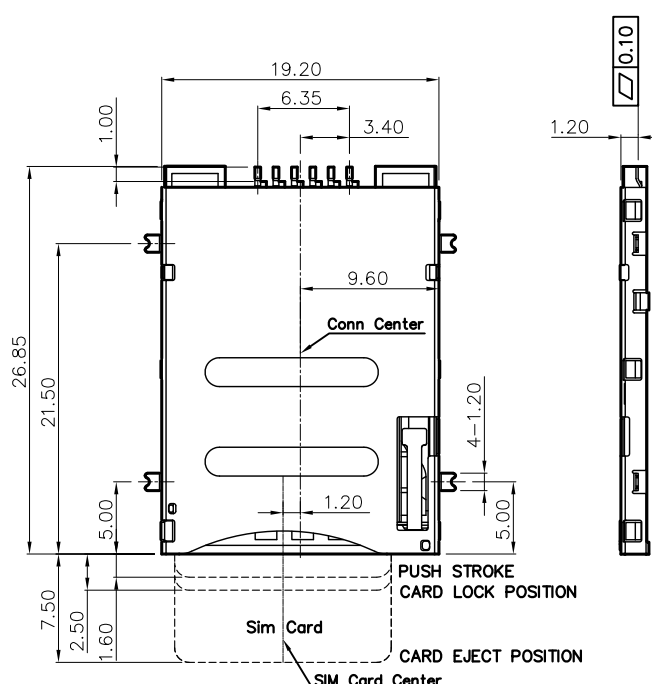


REV.	DESCRIPTION	DATE
A	RELEASE	Nov 28, 2013



RECOMMEND PCB LAYOUT
TOLERANCE: ± 0.05
TOP VIEW

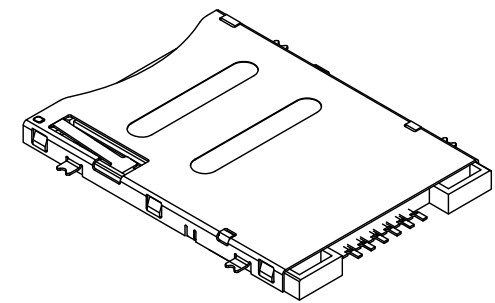
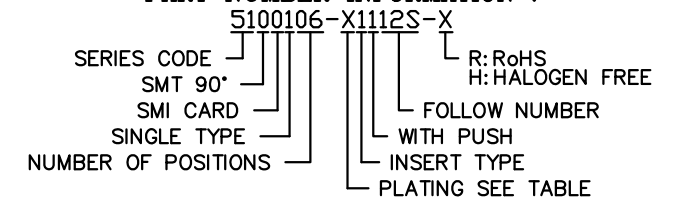
MATERIALS

1. HOUSING : THERMOPLASTIC (UL 94V-0).
2. TERMINAL : COPPER ALLOY, PLATING SEE TABLE.
3. SHELL : SUS. NICKEL PLATED OVERALL.
GOLD PLATED ON SOLDER TAILS.

SPECIFICATION

1. CURRENT RATING : 0.5 A. MAX.
2. DIELECTRIC WITHSTANDING VOLTAGE :
500V AC R.M.S. FOR 1 MINUTE.
3. INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
4. CONTACT RESISTANCE : 100mΩ MAX.
5. OPERATING TEMPERATURE : -40°C TO +85°C.
6. MATING CYCLES : 5000 INSERTIONS.

PART NUMBER INFORMATION :



DESCRIPTION OF PLATING ON TERMINALS			
NO.	EXPLAIN	NO.	EXPLAIN
0	GOLD FLASH	3	GOLD 15u"
1	GOLD 5u"	4	GOLD 20u"
2	GOLD 10u"	H	G/F + TIN

TOLERANCE .0=±0.25 .00=±0.15 .000=±0.05 ANG.=±3°	DRAWER 21 CHECK 21 APP'D 21	INMO 东莞市英墨电子有限公司 INMO Electronics Co.,Ltd NAME SIM CARD PUSH 6PIN 沉板 0.6H DRAW NO. R5100106-X1112S-X	
UNITS : mm	PRODUCT SPEC. —		
SCALE 1:2	SIZE A6	SHEET 1 OF 1	REV. A